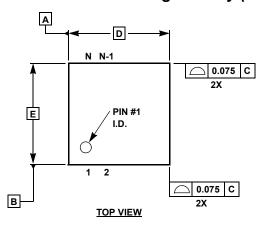
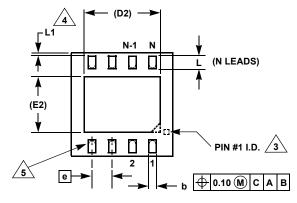
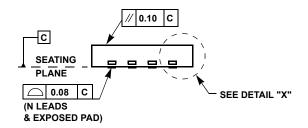
Plastic Packages for Integrated Circuits

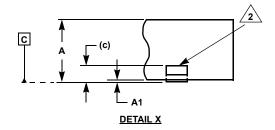
Dual Flat No-Lead Package Family (DFN)





BOTTOM VIEW





MDP0047

DUAL FLAT NO-LEAD PACKAGE FAMILY (JEDEC REG: MO-229)

	MILLIMETERS		
SYMBOL	DFN8	DFN10	TOLERANCE
Α	0.85	0.90	±0.10
A1	0.02	0.02	+0.03/-0.02
b	0.30	0.25	±0.05
С	0.20	0.20	Reference
D	4.00	3.00	Basic
D2	3.00	2.25	±0.05
E	4.00	3.00	Basic
E2	2.20	1.50	±0.05
е	0.80	0.50	Basic
L	0.50	0.50	±0.10
L1	0.10	0	Maximum

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NOTES:

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends).
- 3. Bottom-side pin #1 I.D. may be a diepad chamfer, an extended tiebar tab, or a small square as shown.
- Exposed leads may extend to the edge of the package or be pulled back. See dimension "L1".
- 5. Inward end of lead may be square or circular in shape with radius (b/2) as shown.
- 6. N is the total number of leads on the device.